ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This leve	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier Inform	ation														
Company name*			Company uni	Company unique ID			Unique ID Authority					Response Date*			
onsemi											2025-07-17				
Contact Name			Title - Contact			1	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	rds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	ntative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requeste	r Item Number	Number Mfr Item Number Mfr Item Name NCP189CMTW180TA NCP189 AD slew r G		Mfr Item Name			Effective Date	Version Manufacturing Site		1	Weight*	UOM	Unit Type		
				v rate 1V8 WDFNW	6 2x2	2025-07-17 MY1		ç	0.38	mg	Each				
Ianufacturing	Proccess Information	n													
Terminal Plating / Grid Array Material Terminal Base Alle			Alloy	J-STD-020 MSL Rating Peak Process Body Temperature Max Ti				re Max Time at Peak	Temperat	ure Numl	ber of Reflow Cyc	eles			
Matte Tin (Sn) - annealed		CI	CU Alloy 1		1		260 C		30	secon	ds 3				
omments															
vel 1 - maximum ti	ime at peak temperature d	during solo	dering is 10-3	0 seconds											
or more informatio	on regarding material con	nposition p	olease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.46	mg	Supplier	Silicon (Si)	7440-21-3		0.46	mg
Die Attach	0.23	mg		Epoxy resin	proprietary data		0.0345	mg
			Supplier	Silver (Ag)	7440-22-4		0.184	mg
			Supplier	Bismaleimide	13676-54-5		0.0115	mg
Lead Frame	2.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0462	mg
			Supplier	Tin (Sn)	7440-31-5		0.1618	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0051	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0076	mg
			Supplier	Copper (Cu)	7440-50-8		2.4729	mg
Mold Compound-Black	5.54	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.4155	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.4043	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.277	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.4155	mg
Plating	0.4	mg	Supplier	Tin (Sn)	7440-31-5		0.4	mg
Wire Bond - Cu	0.05	mg	Supplier	Palladium (Pd)	7440-05-3		0.001	mg
			Supplier	Copper (Cu)	7440-50-8		0.049	mg